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To the Honorable Commissioner of Patents

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jc978 U.S. PTO
09/878474
06/11/01

1. Name of conveying party(ies): (1) <u>Frank D. Egitto, and Luis J. Matienzo</u> <i>06/11/01</i> Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO		2. Name and address of receiving party(ies): Name: <u>International Business Machines Corporation</u> Street Address: <u>New Orchard Road</u> City: <u>Armonk</u> State: <u>New York</u> ZIP: <u>10504</u> Additional name(s) & address(es) attached? <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO	
3. Nature of Conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other Execution Date: <u>06/08/01 & 06/11/01</u>			
4. Application number(s) or patent number(s): <i>09/878474</i> If this document is being filed together with a new application, the execution date of the application is: <u>06/08/01 & 06/11/01</u> A. Patent Application Number(s) _____ B. Patent Number(s) _____ Additional number(s) attached? <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO			
5. Name and address of party to whom correspondence concerning document should be mailed: Name: <u>Kevin R. Casey</u> Internal Address: <u>Ratner & Prestia</u> Street Address: <u>Suite 301, One Westlakes, Berwyn,</u> <u>P.O. Box 980</u> <u>Valley Forge, PA 19482-0980</u> Phone: <u>(610) 407-0700</u>		6. Total number of applications and patents involved: 7. Total fee (37 CFR 3.41): <u>\$ 40.00</u> <input type="checkbox"/> Enclosed <input checked="" type="checkbox"/> Authorized to be charged to deposit account 8. Deposit account number: <u>09-0457 (IBM Corporation)</u> (Attach duplicate copy of this page if paying by deposit account.)	

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

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Express Mail Certificate No.: EJ483056947USDate of Deposit: 06/11/01Name of Person Making Deposit: Jennifer SmithSignature: Jennifer Smith

ASSIGNMENT

WHEREAS, we

- (1) **Frank D. Egitto** 27 Karlada Drive, Binghamton, NY 13905;
- (2) **Luis J. Matienzo** of 1211 N. Cafferty Hill Road, Endicott, NY 13760

have invented certain improvements in

**STRUCTURE AND METHOD FOR IMPROVED ADHESION
BETWEEN TWO POLYMER FILMS**

and have executed, respectively, a United States patent application therefor on:

- (1) *6/11/01*, 2001;
- (2) *06/08/01*, 2001;
- (3) , 2001.


Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now, therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and the invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed

(1) at ENDICOTT, NY


on 6/11/01, 2001;



Frank D. Egitto

(2) at ENDICOTT, NY

on 06/08/01, 2001;



Luis J. Matienzo